



## Surface Mount Ultrafast Rectifier



DO-214AC (SMA)

### FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Ultrafast reverse recovery time
- Low switching losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- **Halogen-free according to IEC 61249-2-21 definition**



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### PRIMARY CHARACTERISTICS

|                    |                |
|--------------------|----------------|
| $I_{F(AV)}$        | 1.0 A          |
| $V_{RRM}$          | 50 V to 1000 V |
| $I_{FSM}$          | 30 A           |
| $t_{rr}$           | 50 ns, 75 ns   |
| $V_F$              | 1.0 V, 1.7 V   |
| $T_J \text{ max.}$ | 150 °C         |

### TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, and telecommunication.

### MECHANICAL DATA

**Case:** DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

**Polarity:** Color band denotes cathode end

### MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)

| PARAMETER  | SYMBOL         | US1A          | US1B | US1D | US1G | US1J | US1K | US1M | UNIT |
|--|----------------|---------------|------|------|------|------|------|------|------|
| Device marking code  |                | UA            | UB   | UD   | UG   | UJ   | UK   | UM   |      |
| Maximum repetitive peak reverse voltage  | $V_{RRM}$      | 50            | 100  | 200  | 400  | 600  | 800  | 1000 | V    |
| Maximum RMS voltage  | $V_{RMS}$      | 35            | 70   | 140  | 280  | 420  | 560  | 700  | V    |
| Maximum DC blocking voltage  | $V_{DC}$       | 50            | 100  | 200  | 400  | 600  | 800  | 1000 | V    |
| Maximum average forward rectified current at $T_L = 110\text{ °C}$                 | $I_{F(AV)}$    | 1.0           |      |      |      |      |      |      | A    |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | $I_{FSM}$      | 30            |      |      |      |      |      |      | A    |
| Operating and storage temperature range  | $T_J, T_{STG}$ | - 55 to + 150 |      |      |      |      |      |      | °C   |

# US1A thru US1M

Vishay General Semiconductor



| ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted) |  |                               |      |      |      |      |      |      |      |      |    |
|--|--|-------------------------------|------|------|------|------|------|------|------|------|----|
| PARAMETER  | TEST CONDITIONS  | SYMBOL                        | US1A | US1B | US1D | US1G | US1J | US1K | US1M | UNIT |    |
| Maximum instantaneous forward voltage                                      | 1.0 A  | V <sub>F</sub> <sup>(1)</sup> | 1.0  |      |      |      | 1.7  |      |      |      | V  |
| Maximum DC reverse current at rated DC blocking voltage                    | T <sub>A</sub> = 25 °C   | I <sub>R</sub>                | 10   |      |      |      |      |      |      |      | μA |
|  | T <sub>A</sub> = 100 °C  |                               | 50   |      |      |      |      |      |      |      |    |
| Maximum reverse recovery time  | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A | t <sub>rr</sub>               | 50   |      |      |      | 75   |      |      |      | ns |
| Typical junction capacitance   | 4.0 V, 1 MHz   | C <sub>J</sub>                | 15   |      |      |      | 10   |      |      |      | pF |

**Note**

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted) |                                 |      |      |      |      |      |      |      |      |      |
|---|---------------------------------|------|------|------|------|------|------|------|------|------|
| PARAMETER   | SYMBOL                          | US1A | US1B | US1D | US1G | US1J | US1K | US1M | UNIT |      |
| Maximum thermal resistance  | R <sub>θJA</sub> <sup>(1)</sup> | 75   |      |      |      |      |      |      |      | °C/W |
|   | R <sub>θJL</sub> <sup>(1)</sup> | 27   |      |      |      |      |      |      |      |      |

**Note**

(1) PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad area

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
| US1J-M3/61T                    | 0.064           | 61T                    | 1800          | 7" diameter plastic tape and reel  |
| US1J-M3/5AT                    | 0.064           | 5AT                    | 7500          | 13" diameter plastic tape and reel |

## RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub> = 25 °C unless otherwise noted)

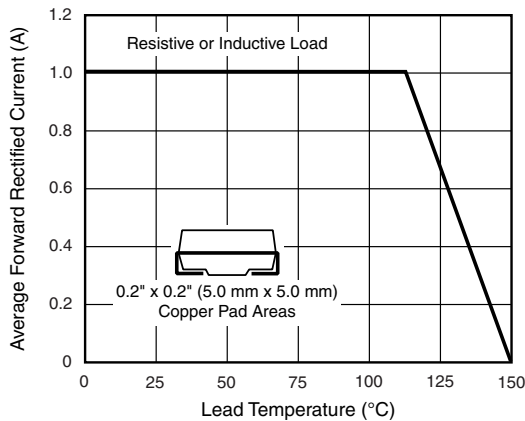


Fig. 1 - Forward Current Derating Curve

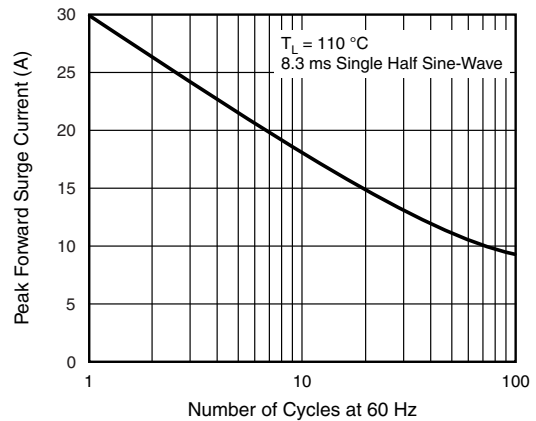


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

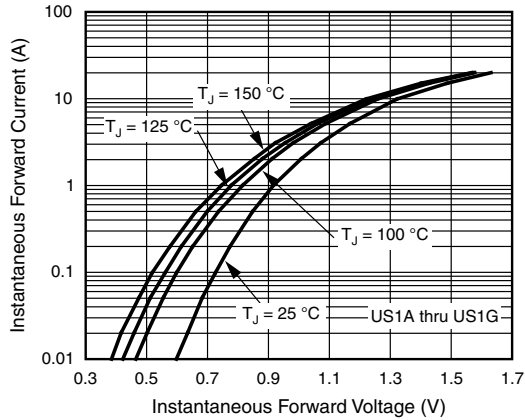


Fig. 3 - Typical Instantaneous Forward Characteristics

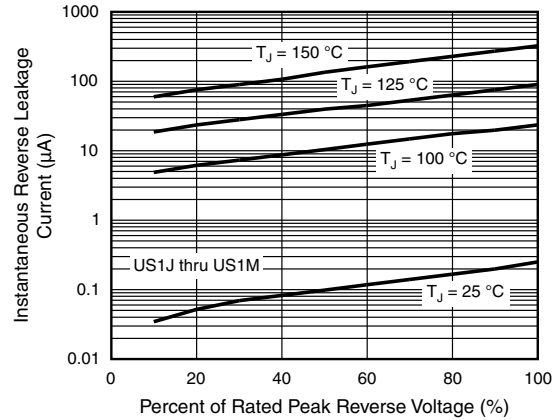


Fig. 6 - Typical Reverse Leakage Characteristics

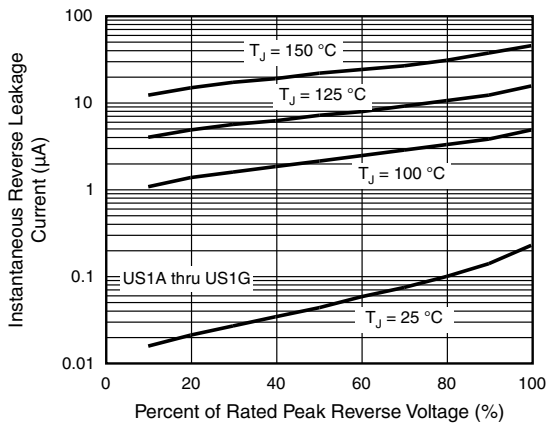


Fig. 4 - Typical Reverse Leakage Characteristics

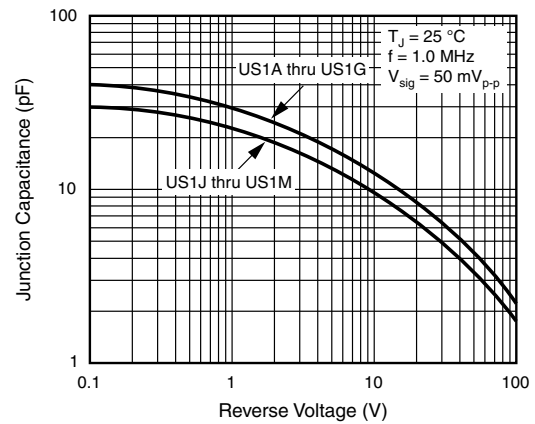


Fig. 7 - Typical Junction Capacitance

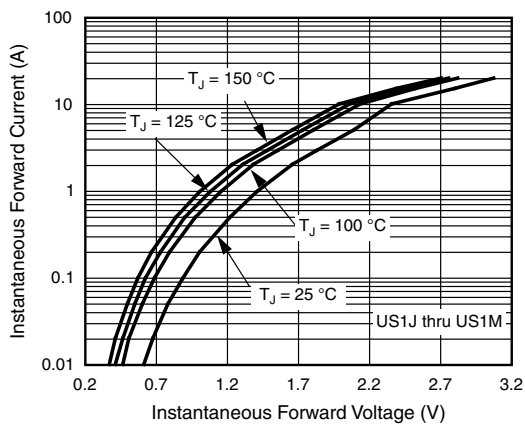


Fig. 5 - Typical Instantaneous Forward Characteristics

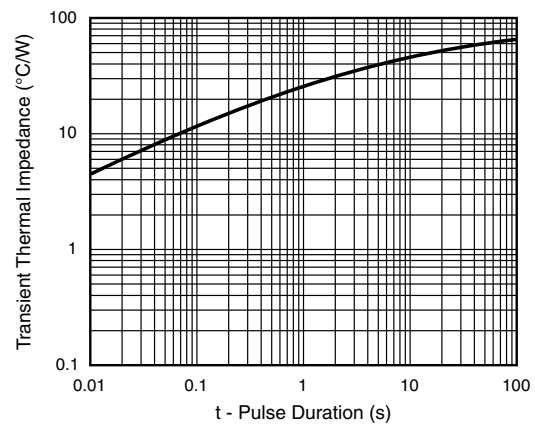


Fig. 8 - Typical Transient Thermal Impedance

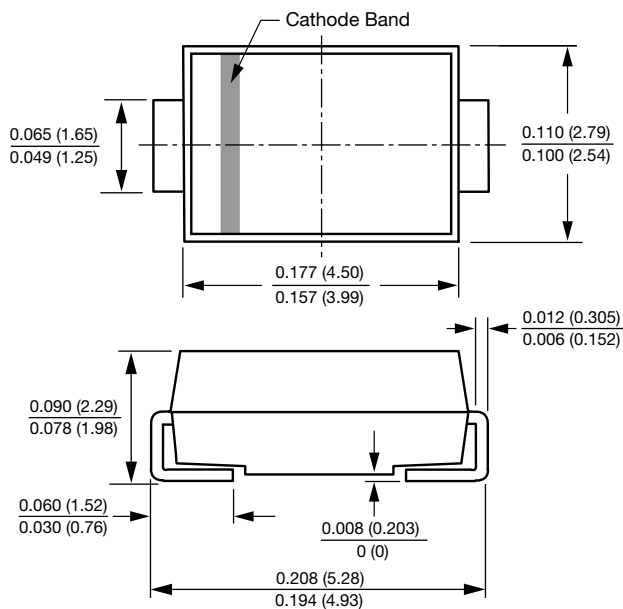
# US1A thru US1M

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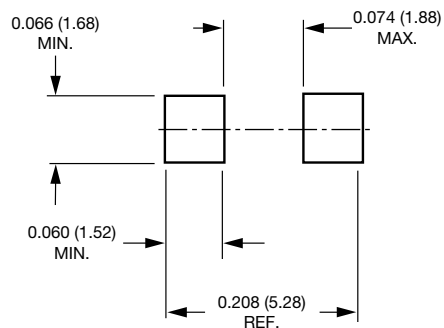


## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### DO-214AC (SMA)



### Mounting Pad Layout





## Disclaimer

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